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The document following this cover page is marked as “Cypress” document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

Continuity of document content

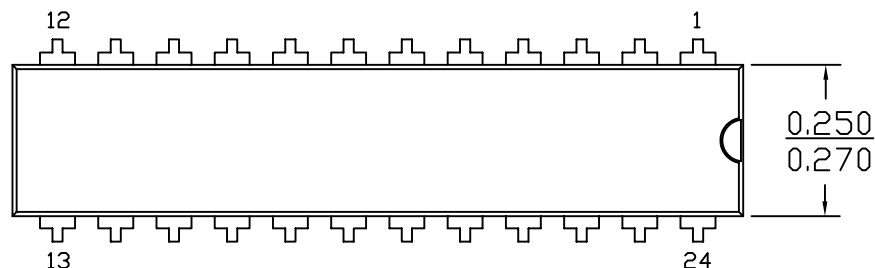
The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

Continuity of ordering part numbers

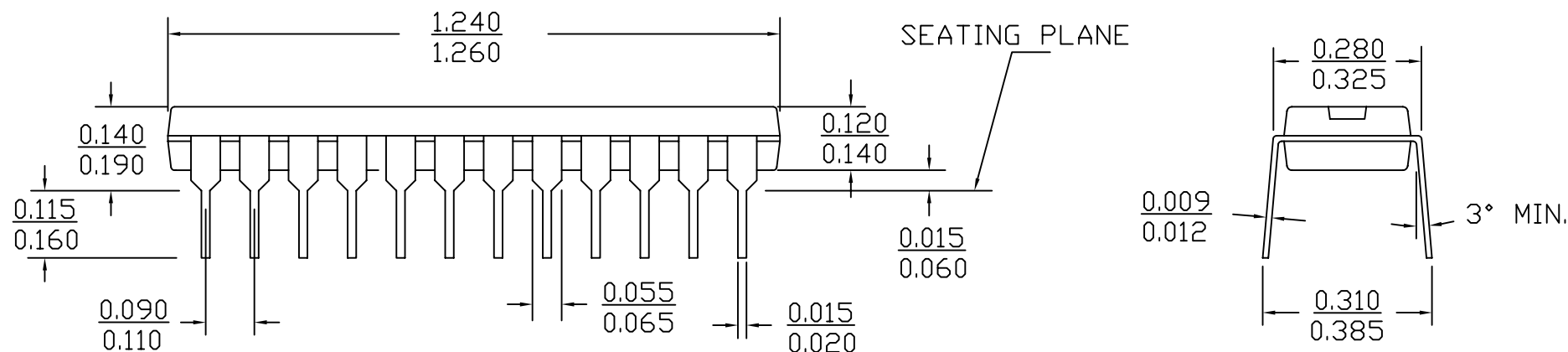
Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.

REVISIONS						
PAGE	ZONE	REV	ECN	DESCRIPTION	DATE	APPROVED
1	-	**	N/A	N/A	N/A	N/A
1	-	*A	49370	CHG. TITLE	04/01/97	N/A
1	-	*B	120895	REMOVE NOTE A, NOTE B & DIM. TABLE	11/01/02	HTN
1	-	*C	2868898	CHANGED TEMPLATE, CHANGE TITLE FROM 24LD (300 MIL) PDIP PKG OUTLINE TO PACKAGE OUTLINE, 24L PDIP 1.260X.270X.140 INCHES P24.3	01/28/10	QAD
1	-	*D	3373659	Update spec for sunset review, no changed	09/21/11	QAD
1	-	*E	4716659	Update spec for sunset review, no changed	04/08/15	QAD


24 Lead (300 Mil) PDIP – P13



DIMENSIONS IN INCHES MIN.
MAX.



<div>UNLESS OTHERWISE SPECIFIED</div> <div>ALL DIMENSIONS ARE IN MILLIMETERS</div> <div>STANDARD TOLERANCES ON:</div> <div>DECIMALS</div> <div>.XX ± 0.05</div> <div>.XXX ±</div> <div>.XXXX +</div> <div>ANGLES</div> <div>± 1°</div>		DESIGNED BY		DATE	
		N/A		N/A	
		DRAWN BY		DATE	
		HTN		11/01/02	
		CHECKED BY		DATE	
		TSV		01/28/10	
		APPROVED BY		DATE	
		QAD		01/28/10	
MATERIAL		APPROVED BY		DATE	
N/A		JGUA		01/28/10	
FINISH		APPROVED BY		DATE	
N/A		N/A		N/A	



CYPRESS

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TITLE

PACKAGE OUTLINE, 24L PDIP 1.260X.270X.140 INCHES P24.3

SIZE	PART NO.	DWG NO	REV
A	P24.3	51-85013	*E
SCALED TO FIT	N/A	SHEET	1 OF 1

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